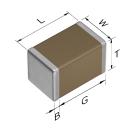
C2012X5R1H225K125AB

RoHS Reach Halogen Free Pb Free

交货型号	C2012X5R1H225KT****
用途	一般等级 车载用途时为 <u>CGA4J3X5R1H225K125AB</u> 。
特点	General 一般(~75V)
系列	C2012 [EIA 0805]
状态	量产体制



)	₹∜
长度(L)	2.00mm ±0.20mm
宽度(W)	1.25mm ±0.20mm
厚度(T)	1.25mm ±0.20mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.50mm Min.
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)
推存序益组/四 (FA)	0.90mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)
]E针件皿加加 (t D)	0.70mm to 0.90mm (Reflow Soldering)
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)
1世代/产血作/四 U U/	0.90mm to 1.20mm(Reflow Soldering)

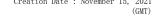
电气特性		
电容	$2.2\muF~\pm10\%$	
额定电压	50VDC	
温度特性	$X5R(\pm 15\%)$	
耗散因数(Max.)	5%	
绝缘电阻(Min.)	227M Ω	

	其他
焊接方法	流体
汗 致刀化	回流
AEC-Q200	NO
包装形式	塑封编带 (180mm卷筒)
包装个数	2000pcs

[!] Images are for reference only and show exemplary products.

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[!] All specifications are subject to change without notice.



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特性图表(这是参考数据,并不保证产品的特性。)

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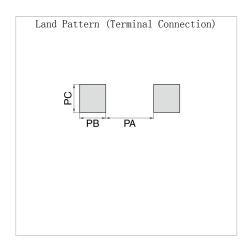
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Associated Images



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